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# LMC568 Low Power Phase-Locked Loop

Check for Samples: LMC568

## FEATURES

- Demodulates ±15% Deviation FM/FSK Signals
- Carrier Detect Output with Hysteresis
- Operation to 500 kHz Input Frequency
- Low THD—0.5% Typ. for ±10% Deviation
- 2V to 9V Supply Voltage Range
- Low Supply Current Drain

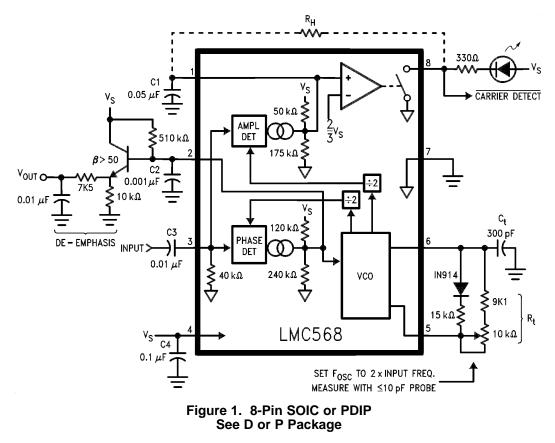
## DESCRIPTION

The LMC568 is an amplitude-linear phase-locked loop consisting of a linear VCO, fully balanced phase detectors, and a carrier detect output. LMCMOS technology is employed for high performance with low power consumption.

The VCO has a linearized control range of  $\pm 30\%$  to allow demodulation of FM and FSK signals. Carrier detect is indicated when the PLL is locked to an input signal greater than 26 mVrms. LMC568 applications include FM SCA and TV second audio program decoders, FSK data demodulators, and voice pagers.

## **Typical Application**

(100 kHz input frequency, refer to Notes to Typical Application)



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## Absolute Maximum Ratings<sup>(1)(2)</sup>

Input Voltage, Pin 3	Input Voltage, Pin 3						
Supply Voltage, Pin 4	Supply Voltage, Pin 4						
Output Voltage, Pin 8	13V						
Voltage at All Other Pins	V <sub>s</sub> to Gnd						
Output Current, Pin 8	30 mA						
Package Dissipation	500 mW						
Operating Temperature Range	e (T <sub>A</sub> )		-25°C to +125°C				
Storage Temperature Range			−55°C to +150°C				
Soldering Information	PDIP Package	Soldering (10 seconds)	260°C				
SOIC Package		Vapor Phase (60 seconds)	215°C				
		Infrared (15 seconds)	220°C				

 "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits.

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

### **Electrical Characteristics**

Test Circuit,  $T_A = 25^{\circ}$ C,  $V_S = 5$ V, RtCt #2, Sw. 1 Pos. 0; and no input unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Units		
14	Power Supply Current	RtCt # 1, Quiescent or Activated	$V_{S} = 2V$		0.35			
			$V_{\rm S} = 5V$		0.75	1.5	mAdc	
			$V_{\rm S} = 9V$		1.2	2.4		
V3	Input D.C. Bias				0		mVdc	
R3	Input Resistance				40		kΩ	
18	Output Leakage				1	100	nAdc	
f <sub>0</sub> C	Center Frequency Fosc ÷ 2	RtCt #2, Measure Oscillator Frequency and	$V_{\rm S} = 2V$		98			
		Divide by 2	$V_{\rm S} = 5V$	90	103	115	kHz	
			$V_{\rm S} = 9V$		105			
$\Delta f_0$	Center Frequency Shift with Supply	$\frac{f_{0 9V} - f_{0 2V}}{7 f_{0 5V}} \times 100$			1.0	2.0	%/V	
V <sub>in</sub> li	Input Threshold	Set Input Frequency Equal to fo Measured	$V_{S} = 2V$	8	16	25	mVrms	
		Above, Increase Input Level until Pin 8 Goes	$V_{\rm S} = 5V$	15	26	42		
		Low.	$V_{\rm S} = 9V$		45			
ΔV <sub>in</sub>	Input Hysteresis	Starting at Input Threshold, Decrease Input Lo 8 Goes High	evel until Pin		1.5		mVrms	
V8	Output "Sat" Voltage	Input Level > Threshold Choose RL for	l8 = 2 mA		0.06	0.15	Vdc	
		Specified I8	l8 = 20 mA		0.7			
L.D.B.W.	Largest Detection	Measure F <sub>osc</sub> with Sw. 1 in Pos. 0, 1, and 2;	$V_{\rm S} = 2V$		30			
	Bandwidth	$  D B W - \frac{F_{osc} P2 - F_{osc} P1}{osc P1} \times 100$	$V_{\rm S} = 5V$	40	55		%	
		Measure $F_{osc}$ with Sw. 1 in Pos. 0, 1, and 2; L.D.B.W. = $\frac{F_{osc} _{P2} - F_{osc} _{P1}}{F_{osc} _{P0}} \times 100$	$V_{S} = 9V$		60			
ΔBW	Bandwidth Skew	Skew = $\left(\frac{F_{osc} _{P2} - F_{osc} _{P1}}{2F_{osc} _{P0}} - 1\right) X 100$			1	±5	%	
V <sub>out</sub>	Recovered Audio	D Typical Application Circuit			170			
		Input = 100 mVrms, F = 100 kHz	$V_{\rm S} = 5V$		270		mVrms	
		$F_{mod} = 400 \text{ Hz}, \pm 10 \text{ kHz Dev}.$	$V_{S} = 9V$		400			



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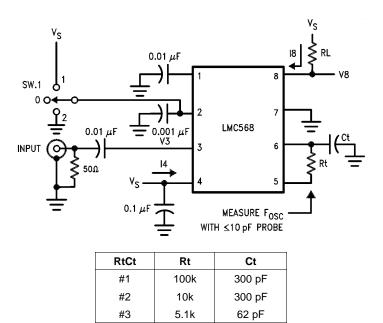
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## **Electrical Characteristics (continued)**

Test Circuit,  $T_A$ = 25°C,  $V_S$ = 5V, RtCt #2, Sw. 1 Pos. 0; and no input unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
THD	Total Harmonic Distortion	Typical Application Circuit as Above, Measure V <sub>out</sub> Distortion.		0.5		%
$\frac{S + N}{N}$	Signal to Noise Ratio	Typical Application Circuit Remove Modulation, Measure $V_n$ (S + N)/N = 20 log ( $V_{out}/V_n$ ).		65		dB
f <sub>max</sub>	Highest Center Freq.	RtCt #3, Measure Oscillator Frequency and Divide by 2		700		kHz

## **Test Circuit**



LMC568

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### Notes to Typical Application

#### SUPPLY DECOUPLING

The decoupling of supply pin 4 becomes more critical at high supply voltages with high operating frequencies, requiring C4 to be placed as close to possible to pin 4. Also, due to pin voltages tracking supply, a large C4 is necessary for low frequency PSRR.

### **OSCILLATOR TIMING COMPONENTS**

The voltage-controlled oscillator (VCO) on the LMC568 must be set up to run at twice the frequency of the input signal. The components shown in the typical application are for Fosc = 200 kHz (100 kHz input frequency). For operation at lower frequencies, increase the capacitor value; for higher frequencies proportionally reduce the resistor values.

If low distortion is not a requirement, the series diode/resistor between pins 6 and 5 may be omitted. This will reduce VCO supply dependence and increase Vout by approximately 2 dB with THD = 2% typical. The center frequency as a function of Rt and Ct is given by:

$$F_{OSC} \cong \frac{1}{1.4 \text{ RtCt}} \text{ Hz}$$
 (1)  
o allow for I.C. and component value tolerences, the oscillator timing components will require a trim. This is  
enerally accomplished by using a variable resistor as part of Rt, although Ct could also be padded. The amount

T g of initial frequency variation due to the LMC568 itself is given in the electrical specifications; the total trim range must also accommodate the tolerances of Rt and Ct.

#### **INPUT PIN**

The input pin 3 is internally ground-referenced with a nominal 40 kΩ resistor. Signals that are centered on 0V may be directly coupled to pin 3; however, any d.c. potential must be isolated via C3.

#### **OUTPUT TAKEOFF**

The output signal is taken off the loop filter at pin 2. Pin 2 is the combined output of the phase detector and control input of the VCO for the phase-locked loop (PLL). The nominal pin 2 source resistance is 80 k $\Omega$ , requiring the use of an external buffer transistor to drive nominal loads.

For small values of C2, the PLL will have a fast acquisition time and the pull-in range will be set by the built-in VCO frequency stops, which also determine the largest detection bandwidth (LDBW). Increasing C2 results in improved noise immunity at the expense of acquisition time, and the pull-in range will become narrower than the LDBW. However, the maximum hold-in range will always equal the LDBW. The 2 kHz de-emphasis pole shown may be modified or omitted as required by the application.

#### **CARRIER DETECT**

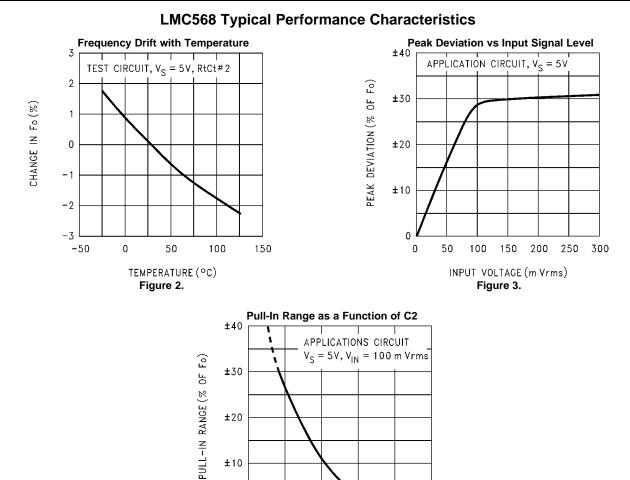
Pin 1 is the output of a negative-going amplitude detector which has a nominal 0 signal output of 7/9 V<sub>s</sub>. The output at pin 8 is an N-channel FET switch to ground which is activated when the PLL is locked and the input is of sufficient amplitude to cause pin 1 to fall below  $2/3 V_s$ . The carrier detect threshold is internally set to 26 mVrms typical on a 5V supply.

Capacitor C1 in conjunction with the nominal 40 k $\Omega$  pin 1 internal resistance forms the output filter. The size of C1 is a tradeoff between slew rate and carrier ripple at the output comparator. Optional resistor R<sub>H</sub> increases the hysteresis in the pin 8 output for applications such as audio mute control. The minimum allowable value for  $R_{H}$  is 330 kΩ.





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10<sup>2</sup>

FoxC2 PRODUCT  $(Hz - \mu F)$ Figure 4.

10

10<sup>3</sup>

10<sup>4</sup>

10<sup>5</sup>

±10

0

1

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# **REVISION HISTORY**

Cł	nanges from Revision A (April 2013) to Revision B Pa	age
•	Changed layout of National Data Sheet to TI format	5

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5-Nov-2017

## **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LMC568CM/NOPB	LIFEBUY	SOIC	D	8		TBD	Call TI	Call TI	-25 to 100	LMC	
										568CM	
LMC568CMX/NOPB	LIFEBUY	SOIC	D	8	2500	Green (RoHS	CU SN	Level-1-260C-UNLIM	0 to 0	LMC	
						& no Sb/Br)				568CM	

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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## PACKAGE OPTION ADDENDUM

5-Nov-2017

## PACKAGE MATERIALS INFORMATION

w

(mm)

12.0

Pin1

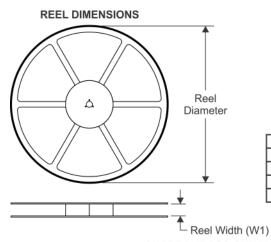
Quadrant

Q1

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## TAPE AND REEL INFORMATION

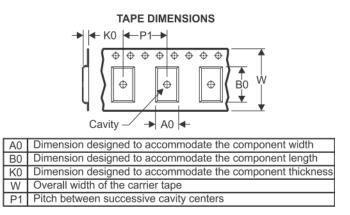


LMC568CMX/NOPB

SOIC

D

8



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



330.0

12.4

6.5

5.4

2.0

8.0

*All dimensions are nominal									
Device	Package Type	Package Drawing		Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)

2500

TEXAS INSTRUMENTS

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## PACKAGE MATERIALS INFORMATION

4-May-2017

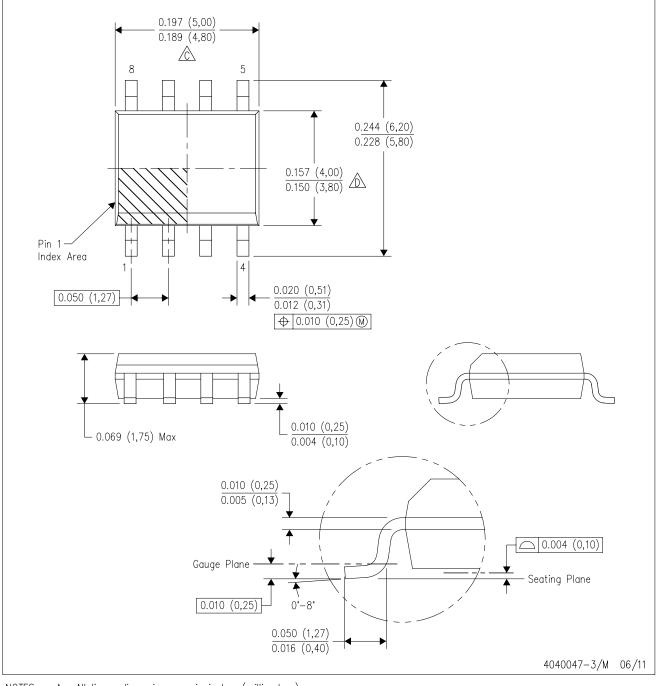


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMC568CMX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.



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